

SN54AS885, SN74AS885 8-BIT MAGNITUDE COMPARATORS

SDAS236A – DECEMBER 1982 – REVISED JANUARY 1995

- Latchable P-Input Ports With Power-Up Clear
- Choice of Logical or Arithmetic (Two's Complement) Comparison
- Data and PLE Inputs Utilize pnp Input Transistors to Reduce dc Loading Effects
- Approximately 35% Improvement in ac Performance Over Schottky TTL While Performing More Functions
- Cascadable to n Bits While Maintaining High Performance
- 10% Less Power Than STTL for an 8-Bit Comparison
- Package Options Include Plastic Small-Outline (DW) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (NT) and Ceramic (JT) 300-mil DIPs

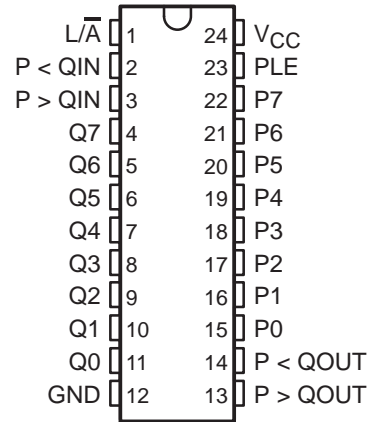
description

These advanced Schottky devices are capable of performing high-speed arithmetic or logic comparisons on two 8-bit binary or two's complement words. Two fully decoded decisions about words P and Q are externally available at two outputs. These devices are fully expandable to any number of bits without external gates. To compare words of longer lengths, the P > QOUT and P < QOUT outputs of a stage handling less significant bits can be connected to the P > QIN and P < QIN inputs of the next stage handling more significant bits. The cascading paths are implemented with only a two-gate-level delay to reduce overall comparison times for long words. Two alternative methods of cascading are shown in *application information*.

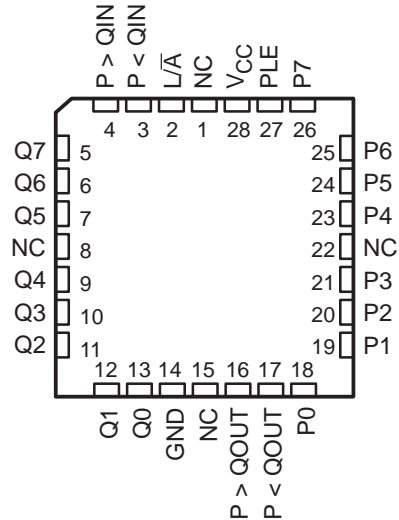
The latch is transparent when P latch-enable (PLE) input is high; the P-input port is latched when PLE is low. This provides the designer with temporary storage for the P-data word. The enable circuitry is implemented with minimal delay times to enhance performance when cascaded for longer words. The PLE, P, and Q data inputs utilize pnp input transistors to reduce the low-level current input requirement to typically -0.25 mA, which minimizes dc loading effects.

The SN54AS885 is characterized for operation over the full military temperature range of -55°C to 125°C. The SN74AS885 is characterized for operation from 0°C to 70°C.

SN54AS885 . . . JT PACKAGE
SN74AS885 . . . DW OR NT PACKAGE
(TOP VIEW)



SN54AS885 . . . FK PACKAGE
(TOP VIEW)



NC – No internal connection

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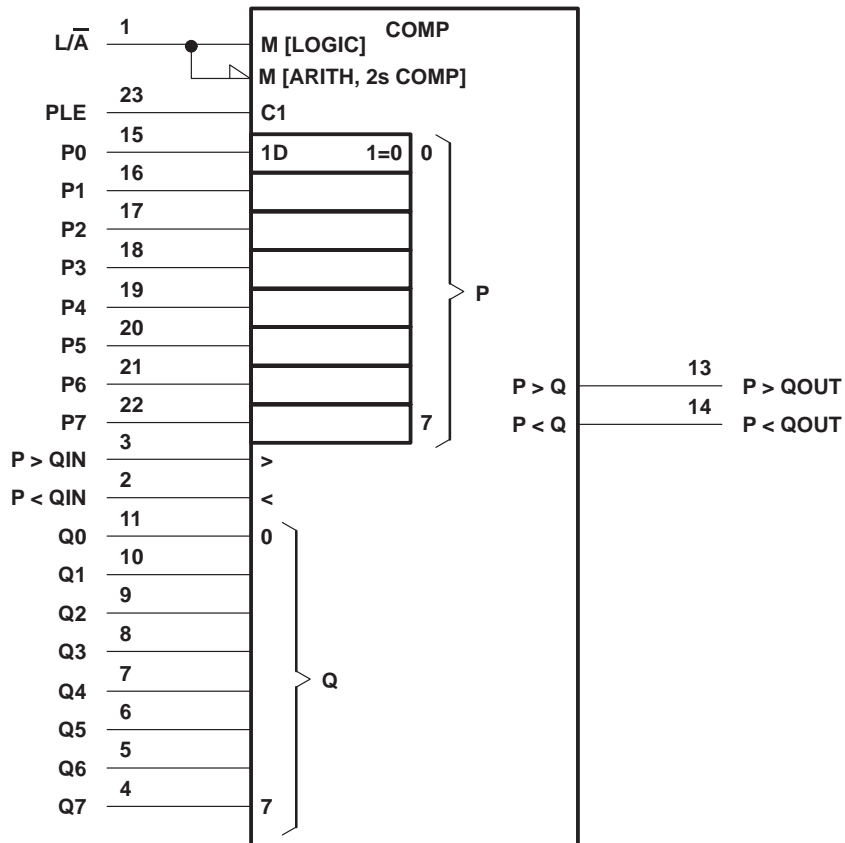
SDAS236A – DECEMBER 1982 – REVISED JANUARY 1995

FUNCTION TABLE

| COMPARISON | INPUTS | | | | OUTPUTS | |
|-------------|------------------|-------------------------|---------|---------|----------|----------|
| | $\overline{L/A}$ | DATA P0–P7, Q0–Q7 | P > QIN | P < QIN | P > QOUT | P < QOUT |
| Logical | H | P > Q | X | X | H | L |
| Logical | H | P < Q | X | X | L | H |
| Logical† | H | P = Q | H or L | H or L | H or L | H or L |
| Arithmetic | L | P AG Q | X | X | H | L |
| Arithmetic | L | Q AG P | X | X | L | H |
| Arithmetic† | L | P = Q | H or L | H or L | H or L | H or L |

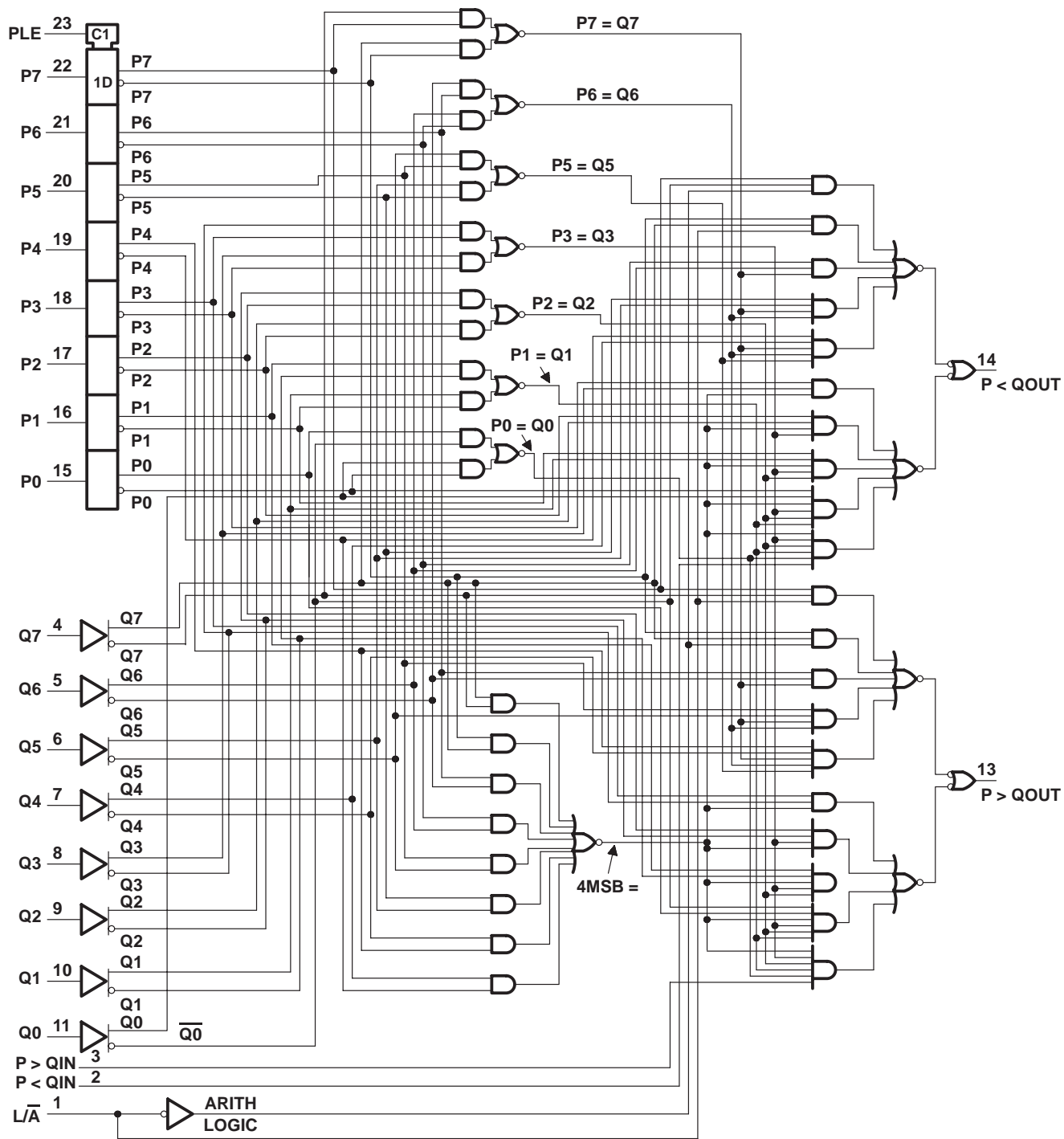
† In these cases, P > QOUT follows P > QIN and P < QOUT follows P < QIN.
AG = arithmetically greater than

logic symbol‡



‡ This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.
Pin numbers shown are for the DW, JT, and NT packages.

logic diagram (positive logic)



Pin numbers shown are for the DW, JT, and NT packages.

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SDAS236A – DECEMBER 1982 – REVISED JANUARY 1995

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

| | |
|---|----------------|
| Supply voltage, V_{CC} | 7 V |
| Input voltage, V_I | 7 V |
| Operating free-air temperature range, T_A : SN54AS885 | -55°C to 125°C |
| SN74AS885 | 0°C to 70°C |
| Storage temperature range | -65°C to 150°C |

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

| | | SN54AS885 | | | SN74AS885 | | | UNIT |
|------------|--------------------------------|-----------|-----|-----|-----------|-----|-----|------|
| | | MIN | NOM | MAX | MIN | NOM | MAX | |
| V_{CC} | Supply voltage | 4.5 | 5 | 5.5 | 4.5 | 5 | 5.5 | V |
| V_{IH} | High-level input voltage | 2 | | | 2 | | | V |
| V_{IL} | Low-level input voltage | | | 0.8 | | | 0.8 | V |
| I_{OH} | High-level output current | | | -2 | | | -2 | mA |
| I_{OL} | Low-level output current | | | 20 | | | 20 | mA |
| t_{su}^* | Setup time, data before PLE↓ | 2 | | | 2 | | | ns |
| t_h^* | Hold time, data after PLE↓ | 4.5 | | | 4 | | | ns |
| T_A | Operating free-air temperature | -55 | | 125 | 0 | | 70 | °C |

* On products compliant to MIL-STD-883, Class B, this parameter is based on characterization data but is not production tested.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | SN54AS885 | | | SN74AS885 | | | UNIT |
|--------------|---|--------------|------|------|--------------|------|------|---------|
| | | MIN | TYP‡ | MAX | MIN | TYP‡ | MAX | |
| V_{IK} | $V_{CC} = 4.5 V$, $I_I = -18 mA$ | | | -1.2 | | | -1.2 | V |
| V_{OH} | $V_{CC} = 4.5 V$ to $5.5 V$, $I_{OH} = -2 mA$ | $V_{CC} - 2$ | | | $V_{CC} - 2$ | | | V |
| V_{OL} | $V_{CC} = 4.5 V$, $I_{OL} = 20 mA$ | 0.35 | 0.5 | | 0.35 | 0.5 | | V |
| I_I | $V_{CC} = 5.5 V$, $V_I = 7 V$ | | 0.1 | | | 0.1 | | mA |
| I_{IH} | L/\bar{A} | | 40 | | | 40 | | μA |
| | Others | | 20 | | | 20 | | |
| I_{IL} | L/\bar{A} | | -4 | | | -4 | | mA |
| | $P > QIN, P < QIN$ | | -2 | | | -2 | | |
| | P, Q, PLE | | -1 | | | -1 | | |
| I_{O}^{\S} | $V_{CC} = 5.5 V$, $V_O = 2.25 V$ | -20 | | -112 | -20 | | -112 | mA |
| I_{CC} | $V_{CC} = 5.5 V$, See Note 1 | | 130 | 210 | | 130 | 210 | mA |

‡ All typical values are at $V_{CC} = 5 V$, $T_A = 25^\circ C$.

§ The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, I_{OS} .

NOTE 1: I_{CC} is measured with all inputs high except L/\bar{A} , which is low.



switching characteristics (see Figure 3)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | V _{CC} = 4.5 V to 5.5 V, C _L = 50 pF, R _L = 500 Ω, T _A = MIN to MAX | | | | | | UNIT |
|------------------|--------------------------|-----------------------|--|------|-----|-----------|------|------|------|
| | | | SN54AS885 | | | SN74AS885 | | | |
| | | | MIN | TYP† | MAX | MIN | TYP† | MAX | |
| t _{PLH} | L/ \bar{A} | P < QOUT, P > QOUT | 2 | 8.5 | 14 | 1 | 8.5 | 13 | ns |
| t _{PHL} | | | 2 | 7.5 | 14 | 1 | 7.5 | 13 | |
| t _{PLH} | P < QIN, P > QIN | P < QOUT, P > QOUT | 2 | 5 | 10 | 1 | 5 | 8 | ns |
| t _{PHL} | | | 2 | 5.5 | 10 | 1 | 5.5 | 8 | |
| t _{PLH} | Any P or Q data input | P < QOUT, P > QOUT | 2 | 13.5 | 21 | 1 | 13.5 | 17.5 | ns |
| t _{PHL} | | | 2 | 10 | 17 | 1 | 10 | 15 | |

† All typical values are at V_{CC} = 5 V, T_A = 25°C.

APPLICATION INFORMATION

The 'AS885 can be cascaded to compare words longer than eight bits. Figure 1 shows the comparison of two 32-bit words; however, the design is expandable to n bits. Figure 1 shows the optimum cascading arrangement for comparing words of 32 bits or greater. Typical delay times shown are at V_{CC} = 5 V, T_A = 25°C and use the standard advanced Schottky load of R_L = 500 Ω, C_L = 50 pF.

Figure 2 shows the fastest cascading arrangement for comparing 16-bit or 24-bit words. Typical delay times shown are at V_{CC} = 5 V, T_A = 25°C and use the standard advanced Schottky load of R_L = 500 Ω, C_L = 50 pF.

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SDAS236A – DECEMBER 1982 – REVISED JANUARY 1995

APPLICATION INFORMATION

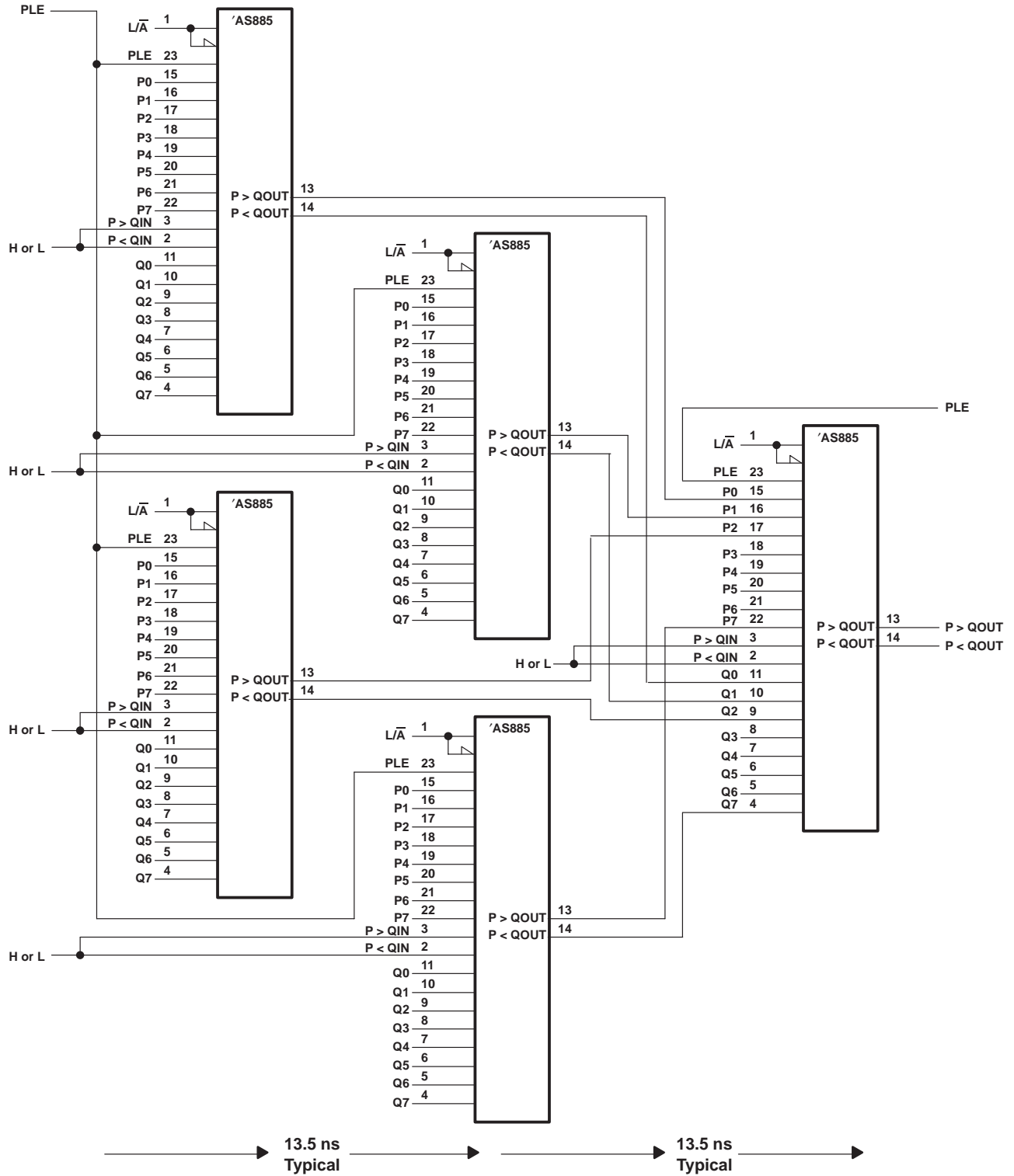


Figure 1. 32-Bit to 72 (n)-Bit Magnitude Comparator

APPLICATION INFORMATION

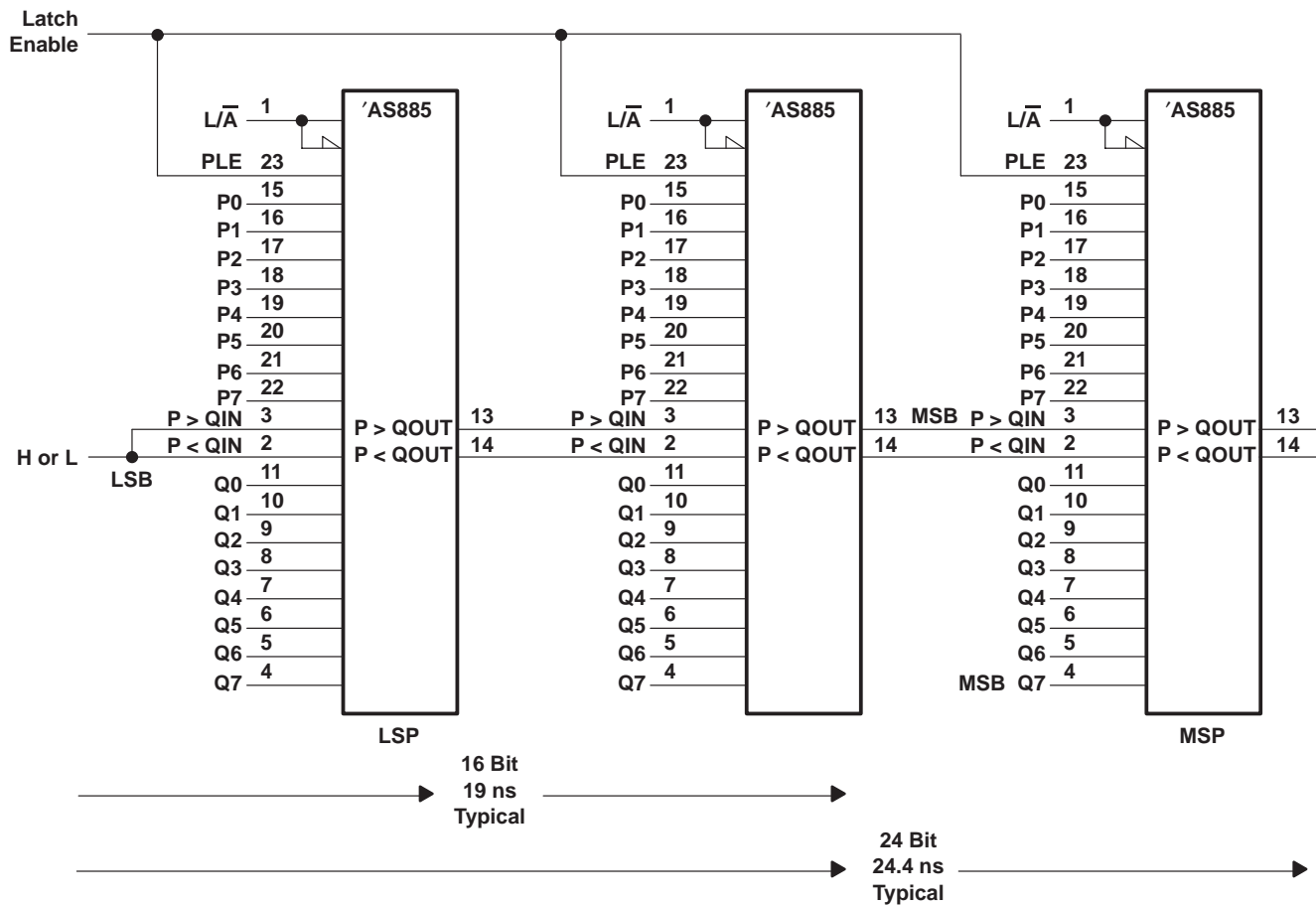
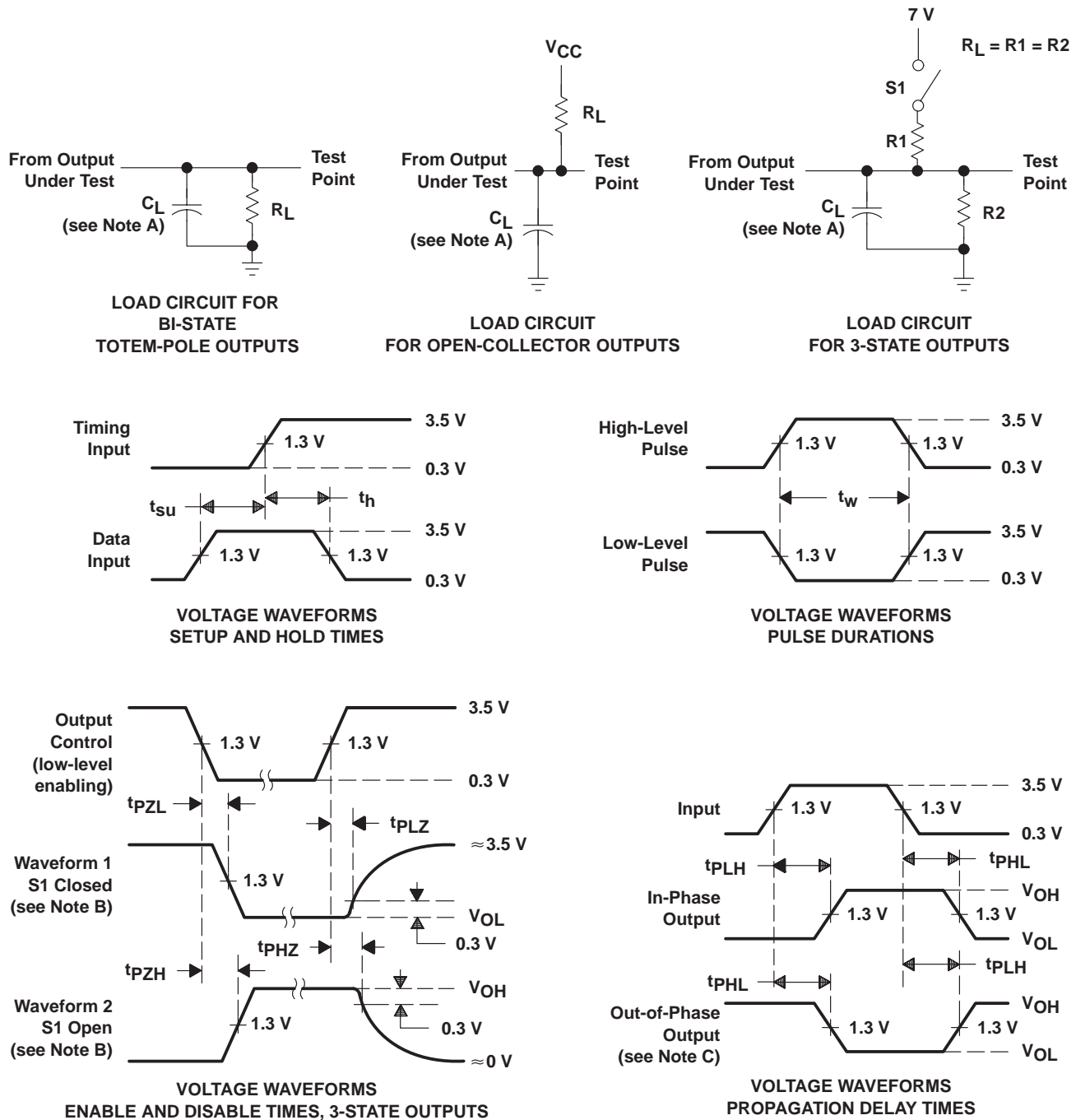


Figure 2. Fastest Cascading Arrangement for Comparing 16-Bit or 24-Bit Words

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SDAS236A – DECEMBER 1982 – REVISED JANUARY 1995

PARAMETER MEASUREMENT INFORMATION SERIES 54ALS/74ALS AND 54AS/74AS DEVICES



- NOTES: A. C_L includes probe and jig capacitance.
 B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
 D. All input pulses have the following characteristics: $PRR \leq 1$ MHz, $t_r = t_f = 2$ ns, duty cycle = 50%.
 E. The outputs are measured one at a time with one transition per measurement.

Figure 3. Load Circuits and Voltage Waveforms

PACKAGING INFORMATION

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins | Package Qty | Eco Plan ⁽²⁾ | Lead/Ball Finish | MSL Peak Temp ⁽³⁾ |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|--|
| 5962-89757013A | ACTIVE | LCCC | FK | 28 | 1 | None | Call TI | Level-NC-NC-NC |
| 5962-8975701KA | ACTIVE | CFP | W | 24 | 1 | None | Call TI | Level-NC-NC-NC |
| 5962-8975701LA | ACTIVE | CDIP | JT | 24 | 1 | None | Call TI | Level-NC-NC-NC |
| SN54AS885JT | ACTIVE | CDIP | JT | 24 | 1 | None | Call TI | Level-NC-NC-NC |
| SN74AS885DW | ACTIVE | SOIC | DW | 24 | 25 | Pb-Free (RoHS) | CU NIPDAU | Level-2-250C-1 YEAR/ Level-1-235C-UNLIM |
| SN74AS885DWR | ACTIVE | SOIC | DW | 24 | 2000 | Pb-Free (RoHS) | CU NIPDAU | Level-2-250C-1 YEAR/ Level-1-235C-UNLIM |
| SN74AS885NT | ACTIVE | PDIP | NT | 24 | 15 | Pb-Free (RoHS) | CU NIPDAU | Level-NC-NC-NC |
| SN74AS885NT3 | OBSOLETE | PDIP | NT | 24 | | None | Call TI | Call TI |
| SNJ54AS885FK | ACTIVE | LCCC | FK | 28 | 1 | None | Call TI | Level-NC-NC-NC |
| SNJ54AS885JT | ACTIVE | CDIP | JT | 24 | 1 | None | Call TI | Level-NC-NC-NC |
| SNJ54AS885W | ACTIVE | CFP | W | 24 | 1 | None | Call TI | Level-NC-NC-NC |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - May not be currently available - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

None: Not yet available Lead (Pb-Free).

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean "Pb-Free" and in addition, uses package materials that do not contain halogens, including bromine (Br) or antimony (Sb) above 0.1% of total product weight.

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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